

Jalapeno is a very powerful quad-core CPU based module with dual band concurrent radio supporting 802.11ac Wave 2 technology

Jalapeno is based on an IPQ4018 SoC from Qualcomm, which is extremely powerful quad core 700MHz CPU Cortex A7 CPU with NEON (high-performance media engine), ideal for routers, gateways and access points. It is a surface mountable, dual-sided, Wi-Fi enabled Linux module.

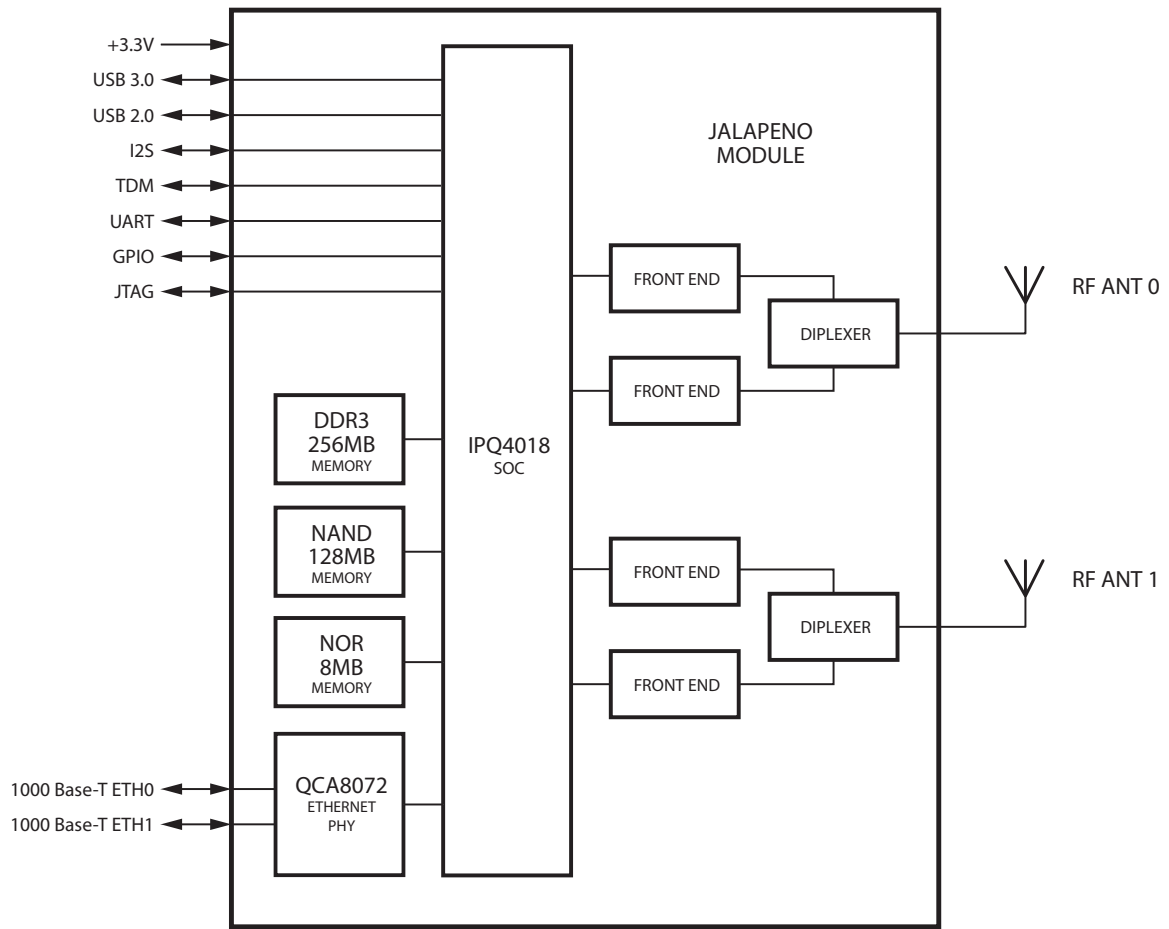
It comes with a high-power (23 dBm per chain) dual-band concurrent radio supporting 802.11ac Wave2 technology (2x2 MiMo) reaching 1.167 Gbps data rate. USB 3.0, USB 2.0, I2S, UART, GPIO are the interfaces available on the module together with two Gigabit Ethernet ports. SoC has hardware NAT engine and high-end security features like crypto engine, secure boot and others.

OpenWRT linux distribution source code is available on GitHub <https://github.com/8devices> and is supported by our growing community on <http://www.8devices.com/community> forum.

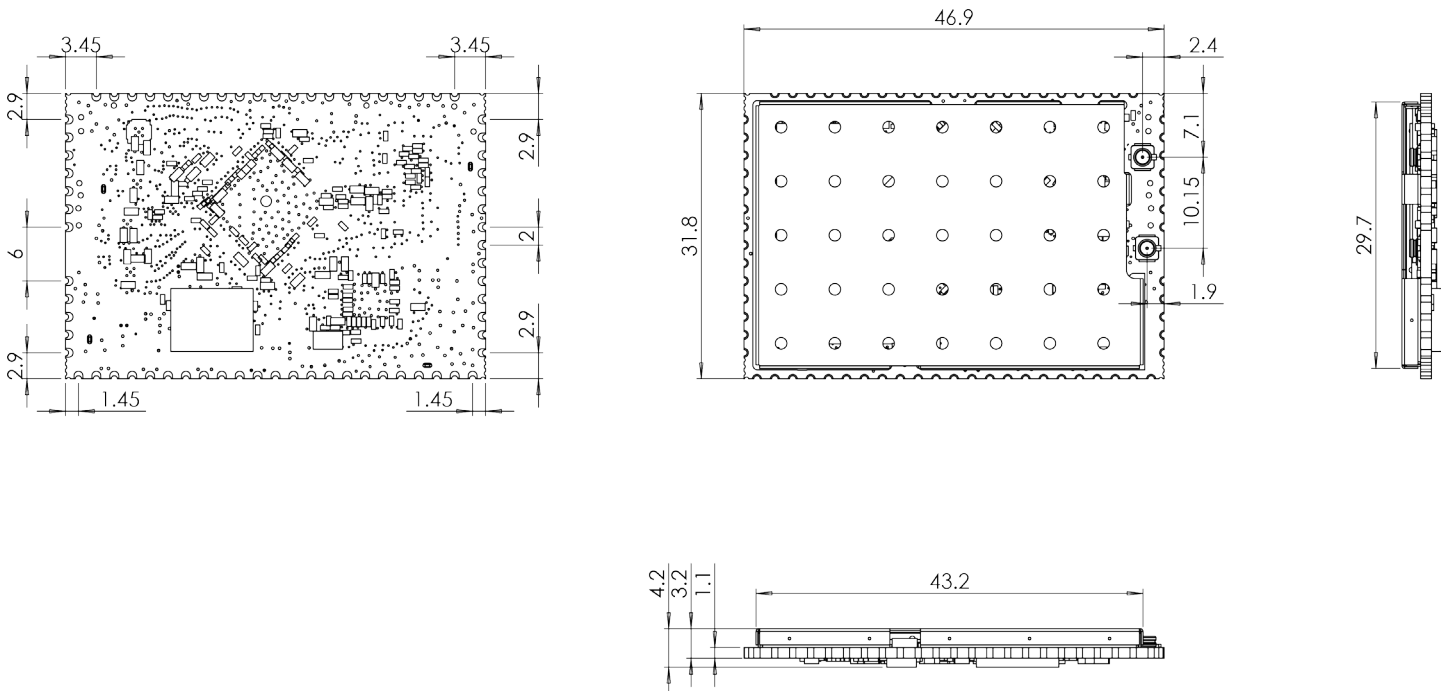
Quick specs

- 802.11 a/b/g/n/ac Wave 2, 2.4 and 5 GHz, 2x2 MIMO, 300 and 867 Mbps data rate, 23 dBm per chain output power
- U.FL connectors for external antenna
- 128 MB NAND and 8 MB NOR FLASH, 256 MB DDR3 RAM
- Linux friendly , OpenWRT flash image and source code are available for download on www.8devices.com/wiki_jalapeno
- CPU – IPQ 4018 (700 MHz quad core Cortex A7)
- 23 dBm per chain output power dual-band concurrent radio with dedicated Tensilica CPU and 802.11ac Wave 2 support
- 32 by 47 mm size
- Surface mountable, dual-side design
- Available interfaces - USB 2.0, USB 3.0, I2S, TDM, UART, GPIO, JTAG and 2 x 1000 Base-T Ethernet ports

Block diagram



Module dimensions



Radio characteristics

2.4 GHz 802.11AC (20 MHz)	Data rate (Mbps)	14.4	28.9	43.3	57.8	86.7	115.6	130.3	144.4	173.3	
	Sensitivity (dBm)	-93	-90	-88	-85	80	-76	-74	-72	-68	
	Output power (dBm)	22	20	19	19	18	18	18	17	17	
2.4 GHz 802.11AC (40 MHz)	Data rate (Mbps)	30	60	90	120	180	240	270	300	360	400
	Sensitivity (dBm)	-90	-88	-85	-82	-77	-73	-73	-70	-66	-64
	Output power (dBm)	21	19	18	18	18	18	17	17	17	17
5 GHz 802.11AC (20 MHz)	Data rate (Mbps)	14.4	28.9	43.3	57.8	86.7	115.6	130.3	144.4	173.3	
	Sensitivity (dBm)	-92	-89	-86	-83	-80	-76	-74	-73	-68	
	Output power (dBm)	22	20	19	19	18	18	18	17	17	
5 GHz 802.11AC (40 MHz)	Data rate (Mbps)	30	60	90	120	180	240	270	300	360	400
	Sensitivity (dBm)	-89	-86	-84	-81	-78	-73	-72	-70	-66	-67
	Output power (dBm)	21	19	18	18	18	18	17	17	17	17
5 GHz 802.11AC (80 MHz)	Data rate (Mbps)	65	130	195	260	390	520	585	650	780	866.7
	Sensitivity (dBm)	-86	-83	-80	-77	-74	-70	-69	-67	-63	-61
	Output power (dBm)	21	19	18	18	18	18	17	17	17	17

Power consumption

Scenario	Voltage, V	Current, A	Power, W
Idle without beacons	5	0.41	2.05
Idle with beacons	5	0.68	3.4
MCS0 HT20	5	2.55	12.75
MCS9 VHT80/HT40 (Highest rates)	5	1.78	8.9

Operating conditions

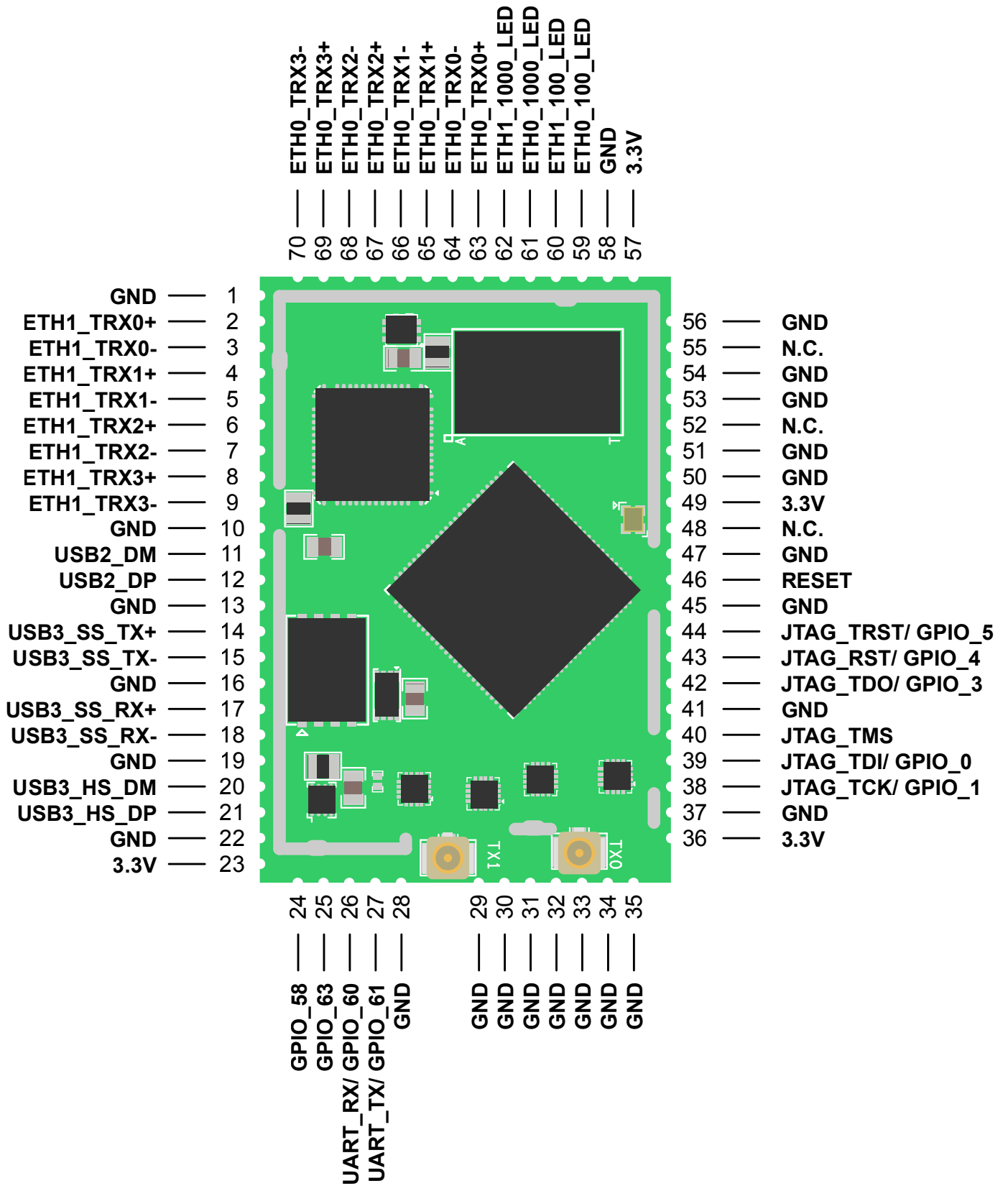
The module can operate in a wide temperature range and different conditions depending on the enclosure. The following guidelines guarantee that it will work correctly.

Parameter	Units	Min	Max
Working environment	°C	0	55
Storage environment	°C	-40	70
Humidity	%RH	10	90
Storage humidity	%RH	5	90

Heatsink size recommendations

It is essential to use heatsink for the hardware designs based on Jalapeno module. Heatsink should be able to dissipate 7W and the recommended area is 175 cm². It should be directly attached to the bottom side of Jalapeno module.

Module pinout



Pin	Name	GPIO function select	Configurable function	Voltage (V)	Type	Description
1	GND	-	-	-	-	Ground connection
2	ETH1_TRX0+	-	-	-	AI, AO	1000 Base-T output positive
3	ETH1_TRX0-	-	-	-	AI, AO	1000 Base-T output negative
4	ETH1_TRX1+	-	-	-	AI, AO	1000 Base-T output positive
5	ETH1_TRX1-	-	-	-	AI, AO	1000 Base-T output negative
6	ETH1_TRX2+	-	-	-	AI, AO	1000 Base-T output positive
7	ETH1_TRX2-	-	-	-	AI, AO	1000 Base-T output negative
8	ETH1_TRX3+	-	-	-	AI, AO	1000 Base-T output positive
9	ETH1_TRX3-	-	-	-	AI, AO	1000 Base-T output negative
10	GND	-	-	-	-	Ground connection
11	USB2_DM	-	-	-	AI, AO	USB 2.0 data negative
12	USB2_DP	-	-	-	AI, AO	USB 2.0 data positive
13	GND	-	-	-	-	Ground connection
14	USB3_SS_TX+	-	-	-	AO	USB 3.0 SuperSpeed transmitter positive
15	USB3_SS_TX-	-	-	-	AO	USB 3.0 SuperSpeed transmitter negative
16	GND	-	-	-	-	Ground connection
17	USB3_SS_RX+	-	-	-	AI	USB 3.0 SuperSpeed receiver positive
18	USB3_SS_RX-	-	-	-	AI	USB 3.0 SuperSpeed receiver negative
19	GND	-	-	-	-	Ground connection
20	USB3_HS_DM	-	-	-	AI, AO	USB 2.0 data negative
21	USB3_HS_DP	-	-	-	AI, AO	USB 2.0 data positive
22	GND	-	-	-	-	Ground connection
23	3.3V	-	-	-	PI	3.3V power supply
24	GPIO58	0	GPIO	3.3	-	-
		2	LED[2]	3.3	O	-
		5	smart_ant6	3.3	IO	-
25	GPIO63	0	GPIO	3.3	-	-
		5	Audio_txd[1]	3.3	O	Audio transmit data
		6	Audio_rxd	3.3	I	Audio receive data
26	UART_RX/GPIO60	0	GPIO	3.3	-	-
		2	blsp_uart0_rxd(1)	3.3	I	UART RX
		4	smart_ant4	3.3	IO	-
		5	LED[0]	3.3	O	-
		6	audio_txbclk	3.3	IO	Audio transmit bit block
		7	audio_rxbclk	3.3	IO	Audio receive bit block
27	UART_TX/GPIO61	0	GPIO	3.3	-	-
		2	blsp_uart0_txd	3.3	O	UART TX
		4	smart_ant5	3.3	IO	-
		5	audio_txfsync	3.3	IO	Audio transmit frame sync
		6	audio_rxfsync	3.3	IO	Audio receiver frame sync
		7	LED[1]	3.3	O	-
			boot_config(14)	3.3	I	-

Pin	Name	GPIO function select	Configurable function	Voltage (V)	Type	Description
28	GND	-	-	-	-	Ground connection
29	GND	-	-	-	-	Ground connection
30	GND	-	-	-	-	Ground connection
31	GND	-	-	-	-	Ground connection
32	GND	-	-	-	-	Ground connection
33	GND	-	-	-	-	Ground connection
34	GND	-	-	-	-	Ground connection
35	GND	-	-	-	-	Ground connection
36	3.3V	-	-	-	PI	3.3V power supply
37	GND	-	-	-	-	Ground connection
38	JTAG_TCK/GPIO1	0	GPIO	3.3	-	-
		1	JTAG_TCK	3.3	I	JTAG test clock
39	JTAG_TDI/GPIO0	0	GPIO	3.3	-	-
		1	JTAG_TDI	3.3	I	JTAG test data in
40	JTAG_TMS	0	GPIO	3.3	-	-
		1	JTAG_TMS	3.3	I	JTAG test mode state
41	GND	-	-	-	-	Ground connection
42	JTAG_TDO/GPIO3	0	GPIO	3.3	-	-
		1	JTAG_TDO	3.3	O	JTAG test data out
		-	boot_config(0)	3.3	I	-
43	JTAG_RST_N/GPIO4	0	GPIO	3.3	-	-
		1	JTAG_RST_N	3.3	I	JTAG reset for debug
44	JTAG_TRST_N/GPIO5	0	GPIO	3.3	-	-
		1	JTAG_TRST_N	3.3	I	JTAG test reset
45	GND	-	-	-	-	Ground connection
46	Reset	-	Module reset	-	I	0 - reset, 1 - run
47	GND	-	-	-	-	Ground connection
48	NC	-	-	-	-	Not connected
49	3.3V	-	-	-	PI	3.3V power supply
50	GND	-	-	-	-	Ground connection
51	GND	-	-	-	-	Ground connection
52	NC	-	-	-	-	Not connected
53	GND	-	-	-	-	Ground connection
54	GND	-	-	-	-	Ground connection
55	NC	-	-	-	-	Not connected
56	GND	-	-	-	-	Ground connection
57	3.3V	-	-	-	PI	3.3V power supply
58	GND	-	-	-	-	Ground connection
59	ETH0_100_LED	-	-	-	AO	LED output for 100 Base-T activity
60	ETH1_100_LED	-	-	-	AO	LED output for 100 Base-T activity
61	ETH0_1000_LED	-	-	-	AO	LED output for 1000 Base-T activity
62	ETH1_1000_LED	-	-	-	AO	LED output for 1000 Base-T activity

Pin	Name	GPIO function select	Configurable function	Voltage (V)	Type	Description
63	ETH0_TRX0+	-	-	-	AI, AO	1000 Base-T output positive
64	ETH0_TRX0-	-	-	-	AI, AO	1000 Base-T output negative
65	ETH0_TRX1+	-	-	-	AI, AO	1000 Base-T output positive
66	ETH0_TRX1-	-	-	-	AI, AO	1000 Base-T output negative
67	ETH0_TRX2+	-	-	-	AI, AO	1000 Base-T output positive
68	ETH0_TRX2-	-	-	-	AI, AO	1000 Base-T output negative
69	ETH0_TRX3+	-	-	-	AI, AO	1000 Base-T output positive
70	ETH0_TRX3-	-	-	-	AI, AO	1000 Base-T output negative

PI - Power input

IO - digital bi-directional signal

O - digital output

I - digital input

AO - analog output

AI - analog input

Power supply

It is recommended to use pin 23, 36, 49 and 57 to give power supply to the module.

Power ratings

Parameter	Units	Min	Nominal	Max
3.3V power supply	V	3.13	3.3	3.46

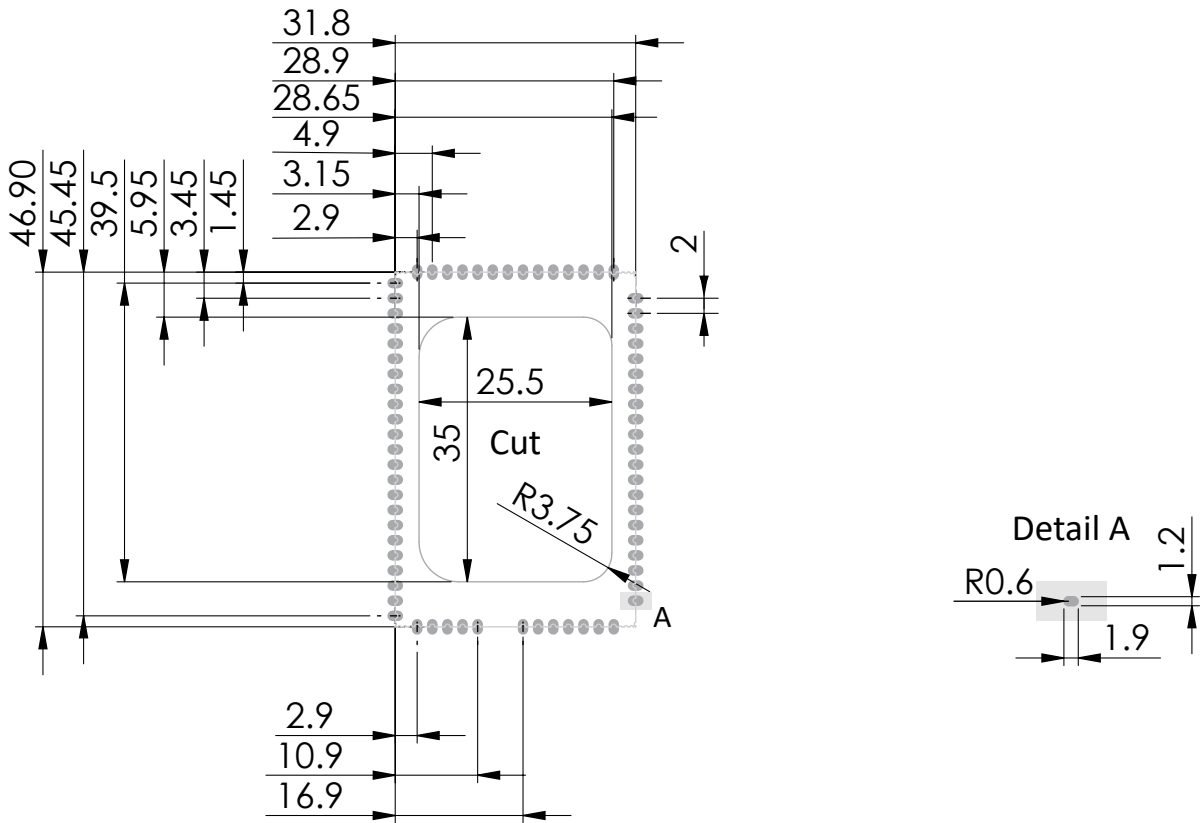
Digital I/O characteristics for 3.3V I/O

Parameter	Comments	Min	Max	Units
V_{IH}	High-level input voltage	2	3.6	V
V_{IL}	Low-level input voltage	-0.3	0.4	V
V_{SHYS}	Schmitt hysteresis voltage	-	-	mV
I_{IH}	Input high leakage current _{11,2}	-	1	μ A
I_{IL}	Input low leakage current _{1,2}	-1	-	μ A
I_{IHPD}	Input high leakage current _{1,3}	10	60	μ A
I_{ILPU}	Input low leakage current _{2,3}	-60	-10	μ A
V_{OH}	High-level output voltage ₄	3.0	3.6	V
V_{OL}	Low-level output voltage ₄	-0.3	0.4	V
I_{OZH}	Tri-state leakage current ₁	-	1	μ A
I_{OZL}	Tri-state leakage current ₂	-1	-	μ A
I_{OZHDP}	Tri-state leakage current _{1,3}	10	60	μ A
I_{OZLPU}	Tri-state leakage current _{2,3}	-60	-10	μ A
C_{IN}	Input capacitance ₅	-	5	pF

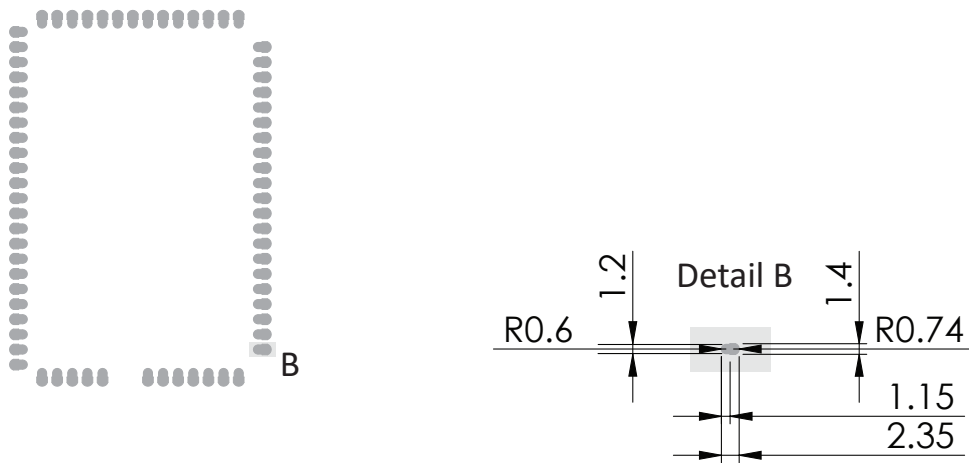
Software

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PCB footprint



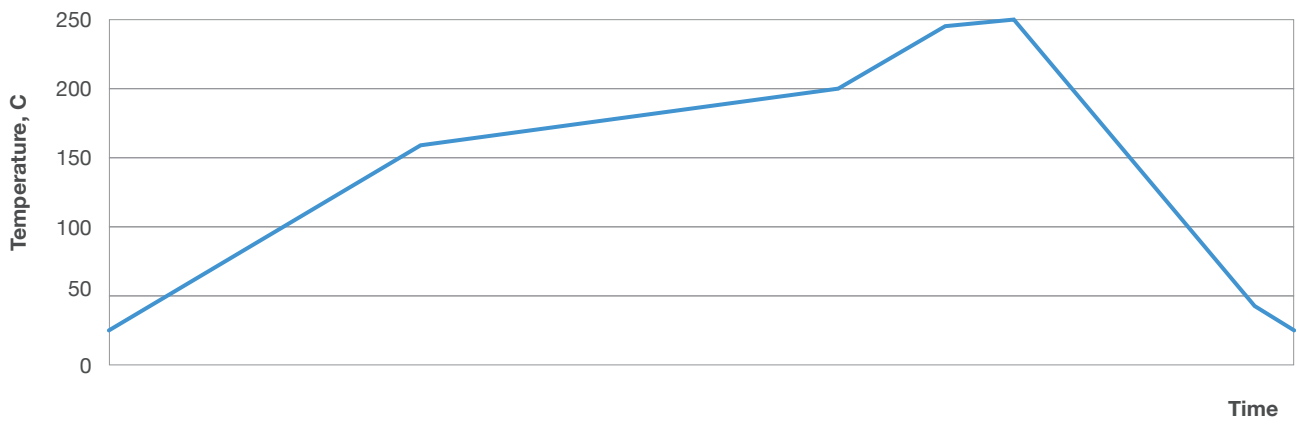
Soldering paste footprint



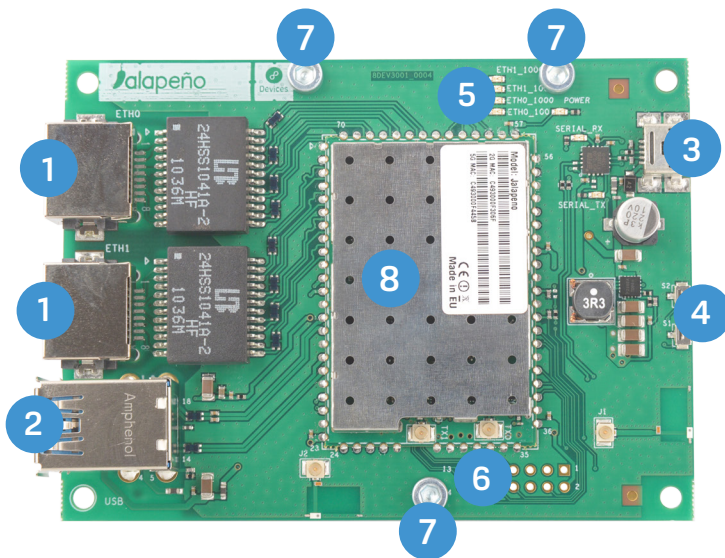
Reflow profile recommendation

Ramp up rate	3°C/second max
Maximum time maintained above 217°C	120 seconds
Peak temperature	250°C
Maximum time within 5°C of peak temperature	20 seconds
Ramp down rate	6°C/second max

Reflow profile



Development kit



- 1 - 2 x 1000 Base-T Ethernet ports
- 2 - 2 x USB Type-A sockets (2.0 and 3.0)
- 3 - Mini USB Type-A socket (console + power)
- 4 - Buttons (reset and user - GPIO connected)
- 5 - External LEDs
- 6 - 2.45 mm pitch prototyping are holes
- 7 - Heatsink mounting screws
- 8 - Jalapeno module

FCC Warning:

If the FCC identification number is not visible when the module is installed inside another device, then the outside of the device into which the module is installed must also display a label referring to the enclosed module. This exterior label can use wording such as the following: "Contains Transmitter Module FCC ID: Z9W-JLP", when the module is installed inside another device, the user manual of this device must contain below warning statements;

1. This device complies with Part 15 of the FCC Rules. Operation is subject to the following two conditions:

(1) This device may not cause harmful interference.

(2) This device must accept any interference received, including interference that may cause undesired operation.

2. Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

NOTE:

This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to Part 15 of the FCC Rules.

These limits are designed to provide reasonable protection against harmful interference in a residential installation.

This equipment generates uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

-Reorient or relocate the receiving antenna.

-Increase the separation between the equipment and receiver.

-Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.

-Consult the dealer or an experienced radio/TV technician for help.

This modular complies with FCC RF radiation exposure limits for an uncontrolled environment. This transmitter must not be co-located or operating in conjunction with any other antenna or transmitter. This modular must be installed and operated with a minimum distance of 20 cm between the radiator and user body.

The device indoor use only for 5150MHz~5250MHz.

This device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions:

(1) This device may not cause harmful interference, and

(2) this device must accept any interference received, including interference that may cause undesired operation.

Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment

IC Warning:

This device complies with Industry Canada's licence-exempt RSSs. Operation is subject to the following two conditions:

(1) This device may not cause interference; and

(2) This device must accept any interference, including interference that may cause undesired operation of the device.

Cet appareil est conforme aux CNR exemptes de licence d'Industrie Canada . Son fonctionnement est soumis aux deux conditions suivantes :

(1) Ce dispositif ne peut causer d'interférences ; et

(2) Ce dispositif doit accepter toute interférence , y compris les interférences qui peuvent causer un mauvais fonctionnement de l'appareil.

This modular complies with IC RF radiation exposure limits set forth for an uncontrolled environment. This transmitter must not be co-located or operating in conjunction with any other antenna or transmitter.

If the IC number is not visible when the module is installed inside another device, then the outside of the device into which the module is installed must also display a label referring to the enclosed module. This exterior label can use wording such as the following:

"Contains IC: 11468A-JLP"

when the module is installed inside another device, the user manual of this device must contain below warning statements;

1. This device complies with Industry Canada's licence-exempt RSSs. Operation is subject to the following two conditions:

(1) This device may not cause interference; and

(2) This device must accept any interference, including interference that may cause undesired operation of the device.

2. Cet appareil est conforme aux CNR exemptes de licence d'Industrie Canada . Son fonctionnement est soumis aux deux conditions suivantes :

(1) Ce dispositif ne peut causer d'interférences ; et

(2) Ce dispositif doit accepter toute interférence , y compris les interférences qui peuvent causer un mauvais fonctionnement de l'appareil.

The devices must be installed and used in strict accordance with the manufacturer's instructions as described in the user documentation that comes with the product

This modular complies with FCC RF radiation exposure limits for an uncontrolled environment. This transmitter must not be co-located or operating in conjunction with any other antenna or transmitter. This modular must be installed and operated with a minimum distance of 20 cm between the radiator and user body.

The device indoor use only for 5150MHz~5250MHz.

Approved antenna:

Antenna Type: Antenna 0: Ceramic Antenna, Antenna 1: Omni Antenna

Antenna gain: Antenna 0: 3dBi, Antenna 1: 10dBi

Manufacture: TDK